

## Surface Mount Glass Passivated Junction Fast Switching Rectifier


**DO-214BA (GF1)**

\* Glass-plastic encapsulation technique is covered by patent No. 3,996,602, brazed-lead assembly by Patent No. 3,930,306 and lead forming by Patent No. 5,151,846

Patented\*

**FEATURES**

- Superectifier structure for high reliability condition
- Patented glass-plastic encapsulation technique
- Ideal for automated placement
- Fast switching for high efficiency
- Low leakage current
- High forward surge capability
- Meets environmental standard MIL-S-19500
- Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC


**RoHS**  
COMPLIANT

**TYPICAL APPLICATIONS**

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive and telecommunication.

**MECHANICAL DATA**

**Case:** DO-214BA, molded epoxy over glass body  
Epoxy meets UL 94V-0 flammability rating

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2 whisker test

**Polarity:** Two bands indicate cathode end - 1st band denotes device type and 2nd band denotes repetitive peak reverse voltage rating

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
$V_{RRM}$	50 V to 1000 V
$I_{FSM}$	30 A
$V_F$	1.3 V
$t_{rr}$	150 ns, 250 ns, 500 ns
$T_J \text{ max.}$	175 °C

MAXIMUM RATINGS ( $T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	UNIT
Device marking code		RA	RB	RD	RG	RJ	RK	RM	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L = 120 \text{ °C}$	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30							A
Max. full load reverse current, full cycle average $T_A = 55 \text{ °C}$	$I_{R(AV)}$	50							$\mu\text{A}$
Operating junction and storage temperature range	$T_J, T_{STG}$	- 65 to + 175							°C



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)											
PARAMETER	TEST CONDITIONS		SYMBOL	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	UNIT
Maximum instantaneous forward voltage	1.0 A		$V_F$	1.3						V	
Maximum DC reverse current at rated DC blocking voltage		$T_A = 25\text{ }^\circ\text{C}$ $T_A = 125\text{ }^\circ\text{C}$	$I_R$	5.0 100						$\mu\text{A}$	
Typical reverse recovery time	$I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $t_{rr} = 0.25\text{ A}$		$t_{rr}$	150				250	500		ns
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	8.5						pF	

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)											
PARAMETER	SYMBOL	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	UNIT		
Typical thermal resistance <sup>(1)</sup>	$R_{\theta JA}$ $R_{\theta JL}$					80 28					$^\circ\text{C/W}$

**Note:**

(1) Thermal resistance from junction to ambient and from junction to lead, P.C.B. mounted on 0.2 x 0.2" (5.0 x 5.0 mm) copper pad areas

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	REFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
RGF1J-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel
RGF1J-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and
RGF1JHE3/67A <sup>(1)</sup>	0.104	67A	1500	7" diameter plastic tape and reel
RGF1JHE3/5CA <sup>(1)</sup>	0.104	5CA	6500	13" diameter plastic tape and

**Note:**

(1) Automotive grade AEC Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES

( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

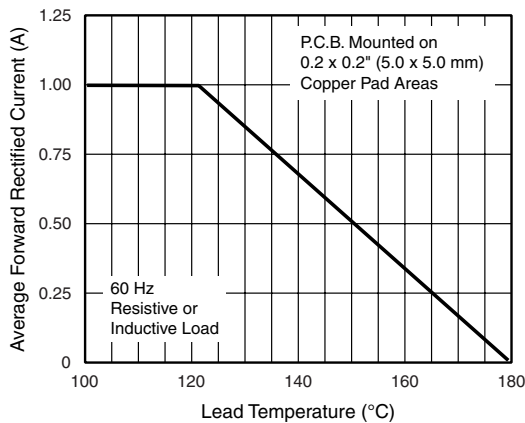


Figure 1. Forward Current Derating Curve

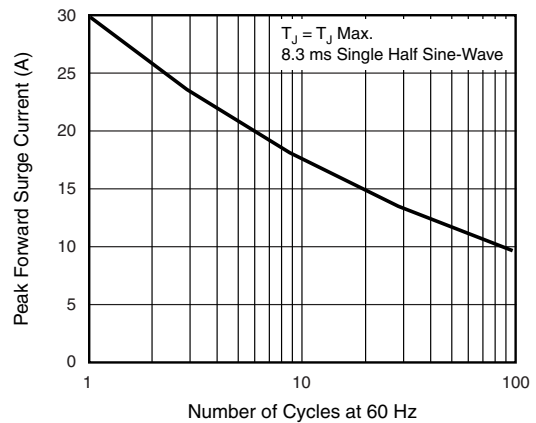


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

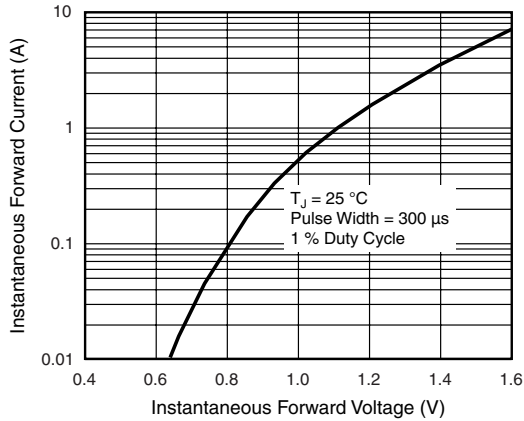


Figure 3. Typical Instantaneous Forward Characteristics

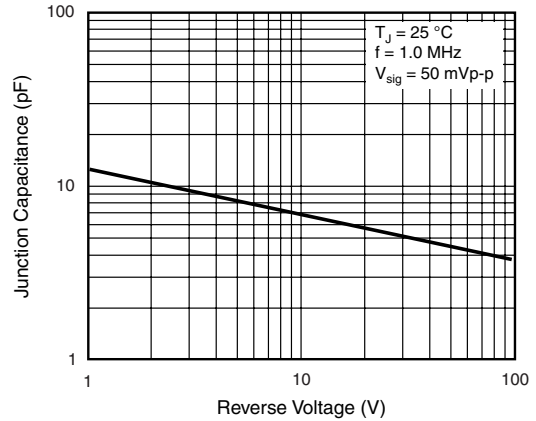


Figure 5. Typical Junction Capacitance

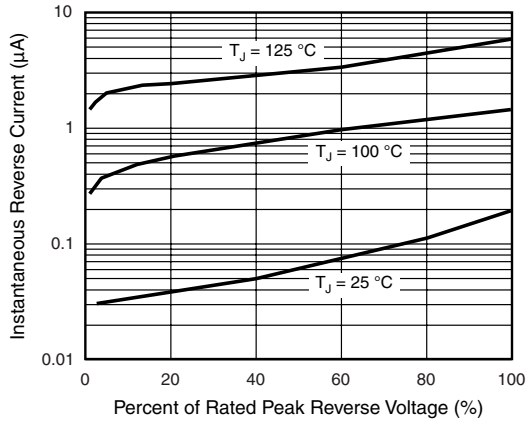


Figure 4. Typical Reverse Characteristics

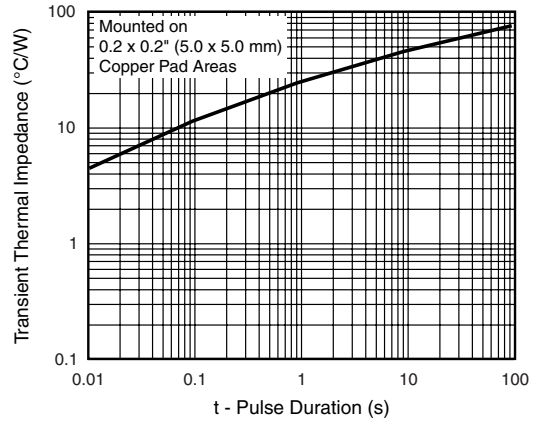
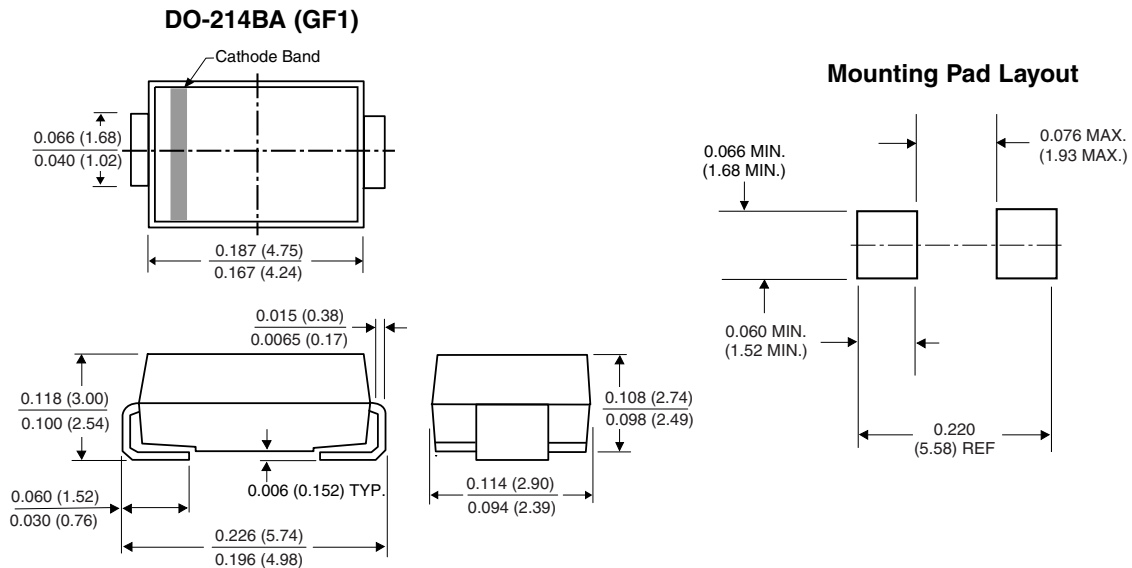


Figure 6. Typical Transient Thermal Impedance

## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





## Disclaimer

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